



60V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	R _{DS(ON)} max	I _D max Tc = +25°C	
60V	35mΩ @ V _{GS} = 10V	33A	
60 V	44mΩ @ V _{GS} = 4.5V	29A	

Description and Applications

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Backlighting
- Power Management Functions
- DC-DC Converters

Features and Benefits

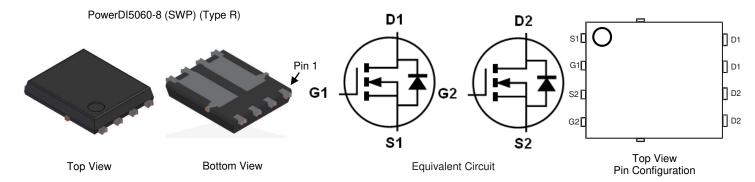
- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switch (UIS) Test in Production
- Low Rds(ON) Minimizes On State Losses
- Low Input Capacitance
- Wettable Flank for Improved Optical Inspections
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Q-suffix) part. A listing can be found at

https://www.diodes.com/products/automotive/automotive-products/.

- This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.
 - https://www.diodes.com/quality/product-definitions/
- An Automotive-Compliant Part is Available Under Separate Datasheet (DMNH6035SPDWQ)

Mechanical Data

- Case: PowerDI[®]5060-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208@3
- Weight: 0.097 grams (Approximate)



Ordering Information (Note 4)

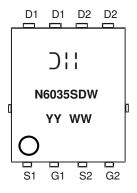
- 1			
	Part Number	Case	Packaging
	DMNH6035SPDW-13	PowerDI5060-8 (SWP) (Type R)	2500 / Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information



];; = Manufacturer's Marking
N6035SDW = Product Type Marking Code
YYWW = Date Code Marking
YY = Year (ex: 20 = 2020)
WW = Week (01 to 53)

Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Drain-Source Voltage	V _{DSS}	60	V
Gate-Source Voltage	V _{GSS}	±20	V
Continuous Drain Current, V _{GS} = 10V (Note 6)	lo	33 21	А
Maximum Body Diode Forward Current (Note 6)	Is	33	Α
Pulsed Drain Current (10μs Pulse, Duty Cycle = 1%)	I _{DM}	132	Α
Pulsed Source Current (10µs Pulse, Duty Cycle = 1%)	Ism	132	Α
Avalanche Current, L = 1mH	las	21.4	Α
Avalanche Energy, L = 1mH	Eas	230	mJ

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Thermal Resistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	62	°C/W	
Total Power Dissipation T _A = +25°C		PD	2.4	W
Thermal Resistance, Junction to Case (Note 6)		Rejc	2.2	°C/W
Total Power Dissipation	T _C = +25°C	P _D	68	W
Operating and Storage Temperature Range	•	TJ, TSTG	-55 to +175	°C

Notes:

^{5.} Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate; measured with 1 channel active.

^{6.} Thermal resistance from junction to solder point (on the exposed drain pin); measured with 1 channel active.



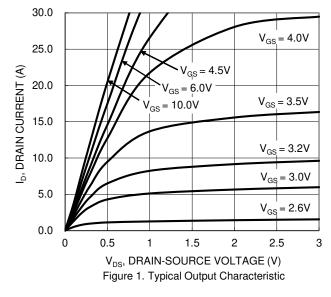
Electrical Characteristics N-Channel (@T_C = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BVDSS	60	_	_	V	$V_{GS} = 0V, I_{D} = 250\mu A$	
Zero Gate Voltage Drain Current	IDSS	_	_	1	μΑ	$V_{DS} = 60V$, $V_{GS} = 0V$	
Gate-Source Leakage	Igss	_	_	±100	nA	V _G S = ±20V, V _D S = 0V	
ON CHARACTERISTICS (Note 7)	•		•	•	•		
Gate Threshold Voltage	V _{GS(TH)}	1	_	3	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	Dagger	_	24	35	mΩ	V _G S = 10V, I _D = 15A	
Static Drain-Source On-Resistance	RDS(ON)	_	33	44	11177	V _{GS} = 4.5V, I _D = 10A	
Diode Forward Voltage	V _{SD}	_	0.75	1.2	V	V _{GS} = 0V, I _S = 2.6A	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	879	_		V _{DS} = 25V, V _{GS} = 0V, f = 1.0MHz	
Output Capacitance	Coss	_	227	_	pF		
Reverse Transfer Capacitance	Crss	_	17	_			
Gate Resistance	Rg	_	2.4	_	Ω	V _{DS} = 0V, V _{GS} = 0V, f = 1.0MHz	
Total Gate Charge (VGS = 6V)	Qg	_	10	_			
Total Gate Charge (V _{GS} = 10V)	Qg	_	16	_	nC	V 00V I 00A	
Gate-Source Charge	Qgs	_	2	_	IIC	$V_{DS} = 30V, I_{D} = 20A$	
Gate-Drain Charge	Qgd	_	4.9	_			
Turn-On Delay Time	td(ON)	_	3.8	_			
Turn-On Rise Time	t _R	_	7.7	_		$V_{DD} = 30V$,	
Turn-Off Delay Time	tD(OFF)	_	19.5	_	ns	$V_{GS} = 10V, R_{G} = 4.7\Omega, I_{D} = 20A$	
Turn-Off Fall Time	tϝ	_	5.8	_			
Body Diode Reverse Recovery Time	trr	_	28	_	ns	IF = 20A, di/dt = 100A/µs	
Body Diode Reverse Recovery Charge	Q _{RR}	_	28	_	nC	I _F = 20A, di/dt = 100A/µs	

Notes:

^{7.} Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing.





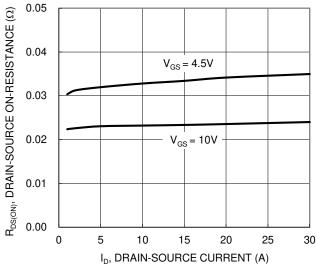
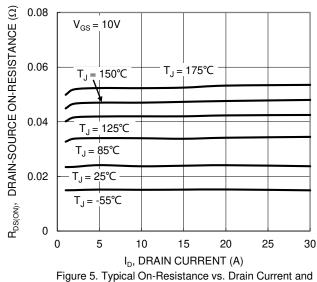


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage



Temperature

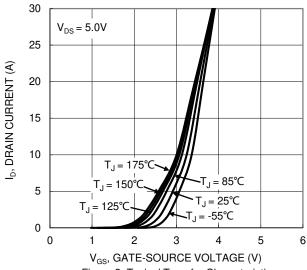


Figure 2. Typical Transfer Characteristic

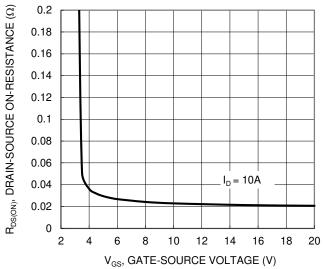


Figure 4. Typical Transfer Characteristic

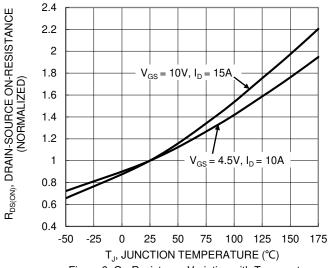


Figure 6. On-Resistance Variation with Temperature



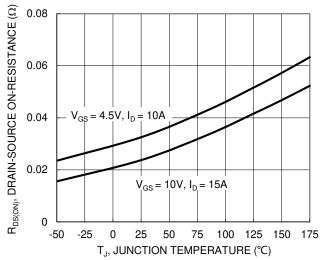
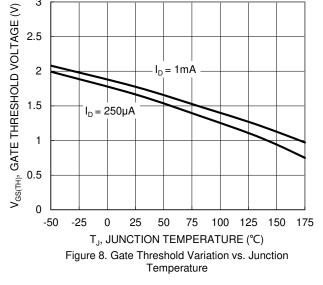


Figure 7. On-Resistance Variation with Temperature



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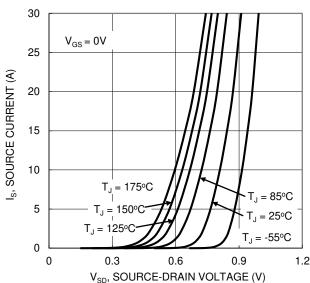
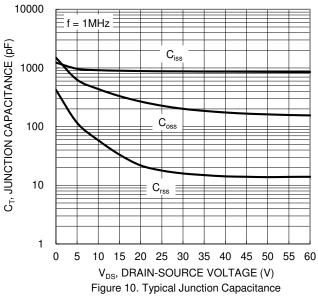
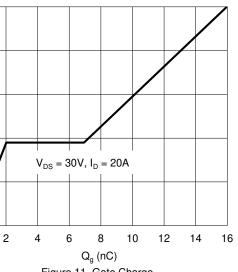
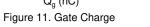


Figure 9. Diode Forward Voltage vs. Current







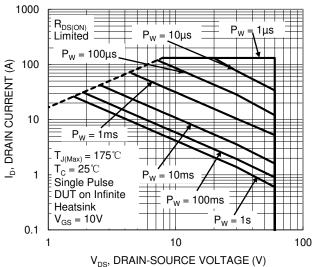


Figure 12. SOA, Safe Operation Area

10

8

6

4

2

0

0

 $V_{GS}(V)$



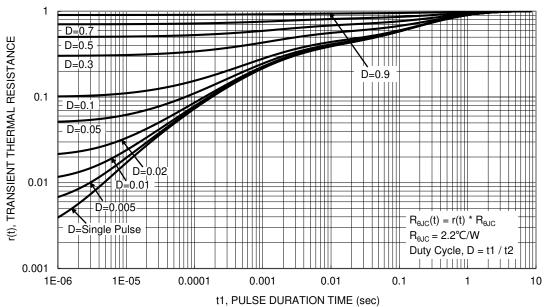
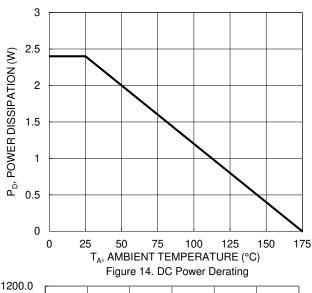
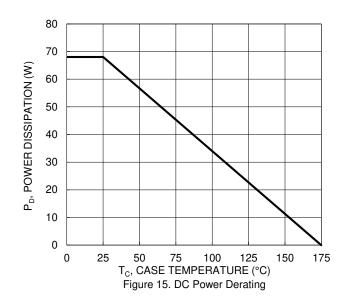


Figure 13. Transient Thermal Resistance





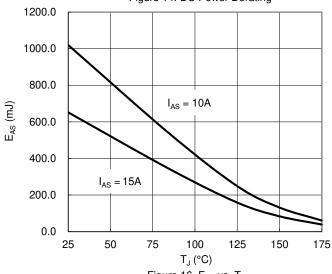


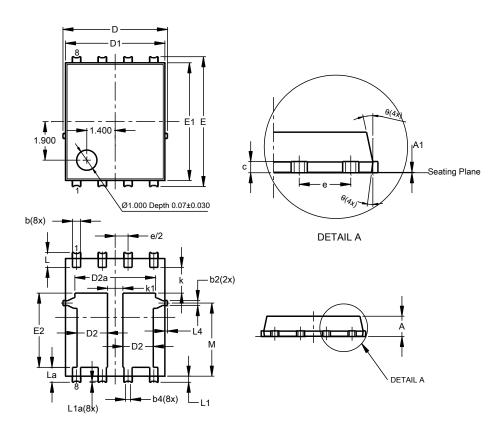
Figure 16. E_{AS} vs. T_{J}



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (SWP) (Type R)

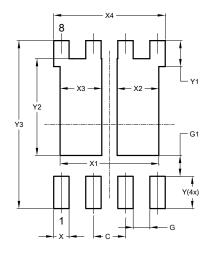


Pov	PowerDI5060-8 (SWP) (Type R)					
Dim	Min	Max	Тур			
Α	0.90	1.10	1.00			
A 1	0	0.05				
b	0.30	0.50	0.41			
b2	0.20	0.35	0.25			
b4	C	.25REF				
С	0.230	0.330	0.277			
D		.15 BS0	\sim			
D1	4.70	5.10	4.90			
D2	1.40	1.60	1.50			
D2a	3.78	4.18	3.98			
E	6	.40 BS0)			
E1	5.60	6.00 3.86	5.80			
E2	3.46	3.66				
е		.27BSC)			
k	1.05					
k1	0.56					
L	0.635	0.835	0.735			
La	0.635	0.835	0.735			
L1	0.200	0.400	0.300			
L1a	0.050REF					
L4	0.025	0.225	0.125			
М	3.205	4.005	3.605			
θ	10°	12°	11°			
θ1	6°	8°	7°			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (SWP) (Type R)



Dimensions	Value (in mm)		
С	1.270		
G	0.660		
G1	0.820		
Х	0.610		
X1	3.910 1.650		
X2			
Х3	1.650		
X4	4.420		
Y	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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